

Device Features

- OIP3 = 45.0 dBm @ 2140 MHz
- Gain = 14.0 dB @ 2140 MHz
- Output P1 dB = 27.2 dBm @ 2140 MHz
- Patented Over Voltage Protection Circuit
- RoHS2-compliant SOT-89 SMT package



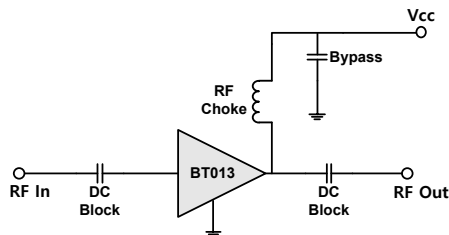
Product Description

BeRex's BT013 is a high performance and a high dynamic range amplifier in a low cost surface mount package(SOT-89) with a RoHS2-compliant, that incorporates reliable heterojunction-bipolar-transistor (HBT) devices fabricated with InGaP GaAs technology. This device is designed for use where high linearity is required and features high OIP3 and P1 with low consumption current (135mA) and requires a few external matching components such as a DC blocking capacitors on the In/Output pin, a bypass capacitor and a RF choke for the out port. All devices are 100% RF/DC tested.

Applications

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system
- Wireless LAN

Application Circuits



*External matching circuit: refer to the page 6 to 12.

Electrical Specifications

Device performance _ measured on a BeRex evaluation board at 25°C, Vc=5V, 50 Ω system.

Parameter	Conditions	Min	Typ	Max	Unit
Operational Frequency Range		1500		4000	MHz
Test Frequency			2140		MHz
Gain		12.5	14.0		dB
Input Return Loss			-12.0		dB
Output Return Loss			-12.0		dB
Output IP3	13 dBm/tone, Δf=1 MHz	42.0	45.0		dBm
Output P1dB		25.2	27.2		dBm
WCDMA 4FA ACLR*		15.7	16.7		dBm
Noise Figure			6.8		dB

*ACLR Channel Power measured at -50dBc.

- ACLR Test set-up: 3GPP WCDMA, TM1+64DPCH, +5MHz offset.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Unit
Bandwidth	1500		4000	MHz
I _c @ (V _c = 5V)	110	135	160	mA
V _c	4.75	5.0	5.25	V
R _{TH}		50		°C/W
Operating Case Temperature	-40		+85	°C

Electrical specifications are measured at specified test conditions.

Specifications are not guaranteed over all recommended operating conditions.

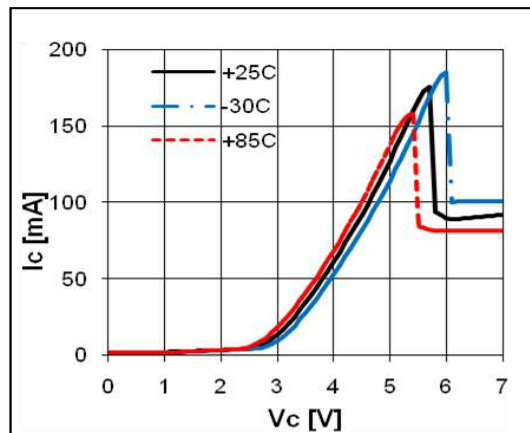
Absolute Maximum Ratings

Parameter	Rating	Unit
Storage Temperature	-55 to +155	°C
Junction Temperature	+185	°C
Supply Voltage	+7.0	V
Supply Current	200	mA
Input RF Power	23	dBm

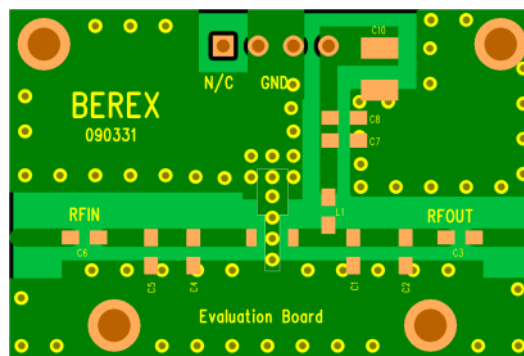
*Operation of this device above any of these parameters may result in permanent damage.

Typical Performance (Vc=5V, Ic=135mA, T=25°C)

Parameter	Frequency				Unit
	1900	2140	2400	3500	MHz
Gain	15.0	14.0	13.2	10.7	dB
S11	-17.5	-12.0	-13.0	-26.0	dB
S22	-12.5	-12.0	-13.0	-25.0	dB
OIP3	45.0	45.0	43.0	40.0	dBm
P1dB	27.5	27.2	27.0	26.0	dBm
IS-95C ACPR	20.1	-	-	-	dBm
WCDMA ACLR	-	16.7	17.5	-	dBm
Noise Figure	6.8	6.8	6.8	7.1	dB

V-I Characteristics


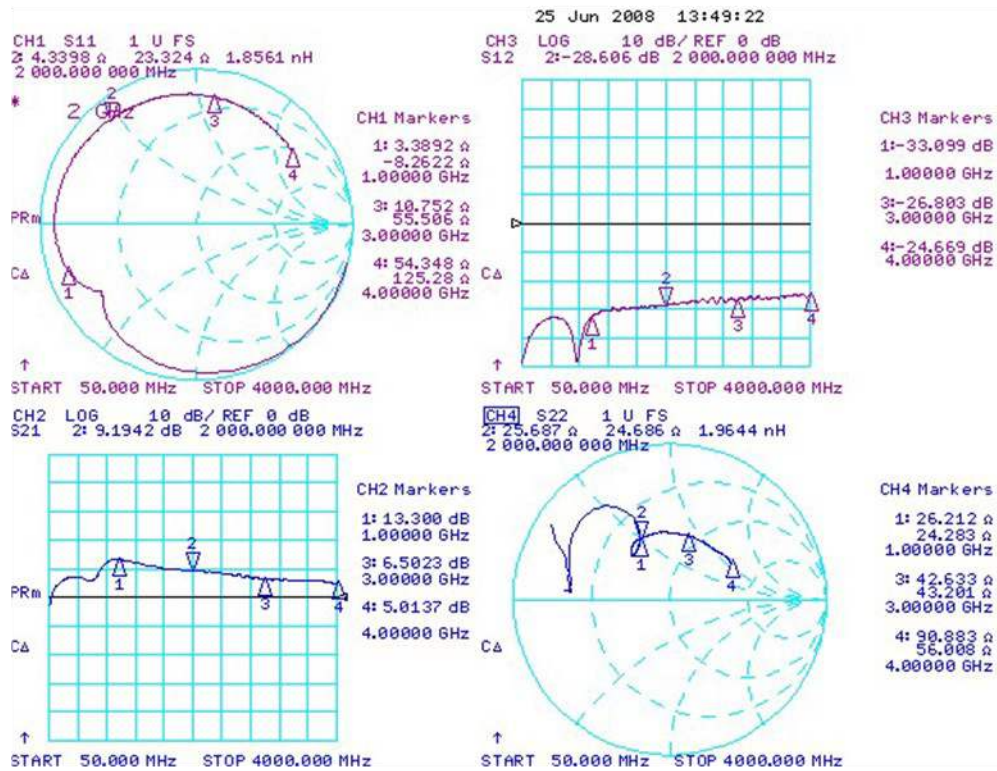
*Voltage protection works at 5~6 V

BeRex SOT89 Evaluation Board


*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

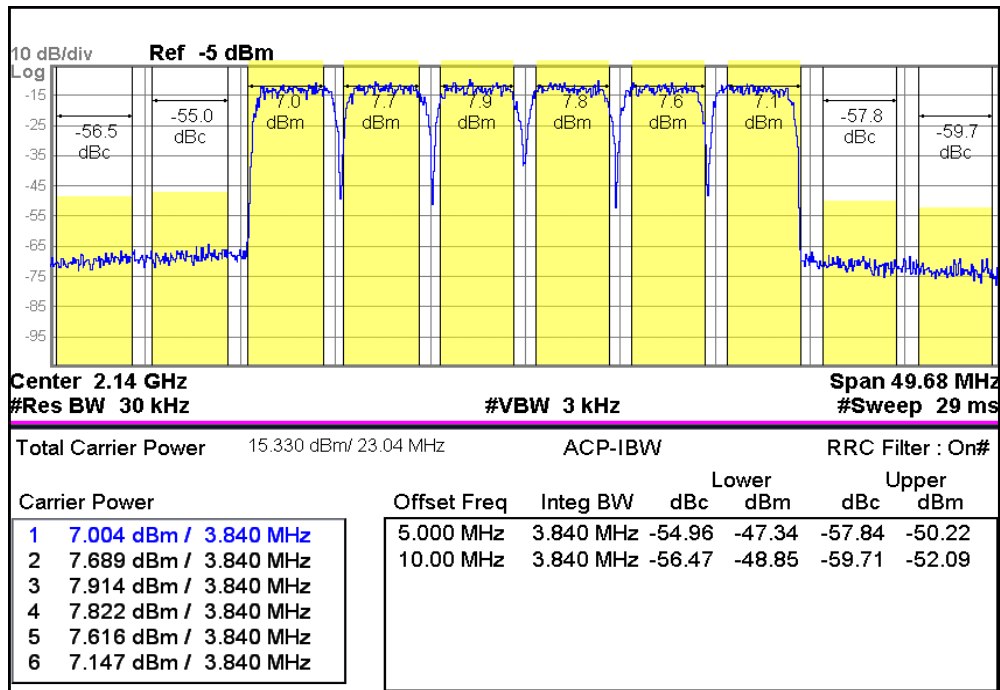
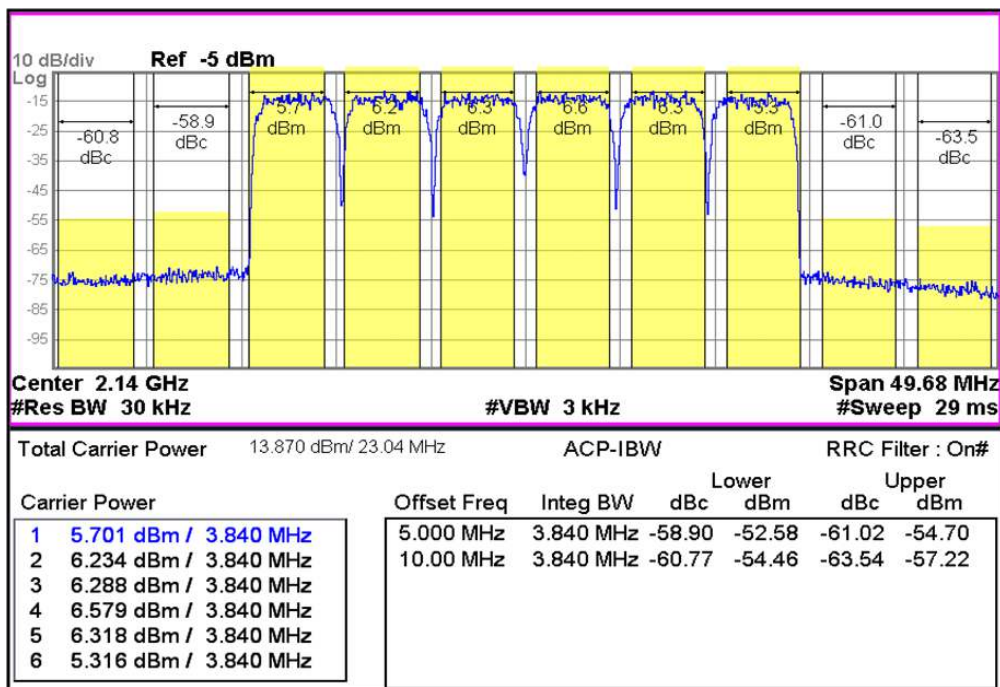
S-parameters (Vc=5V, Ic=135mA, T=25°C)



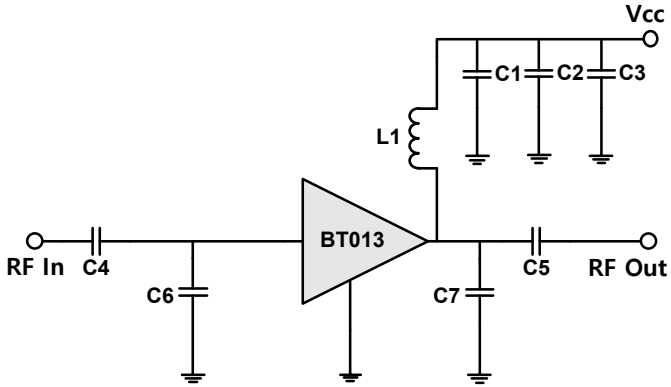
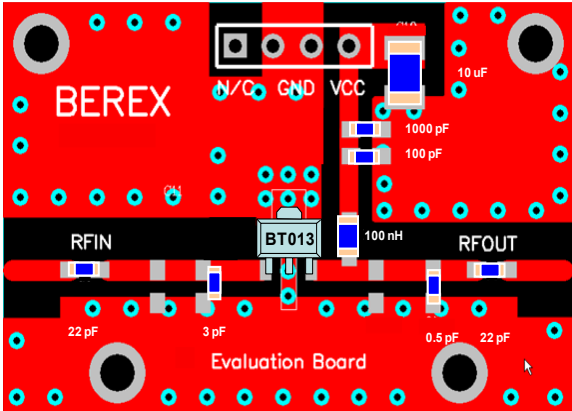
S-Parameter

(Vdevice = 5.0V, Icc = 135mA, T = 25 °C, calibrated to device leads)

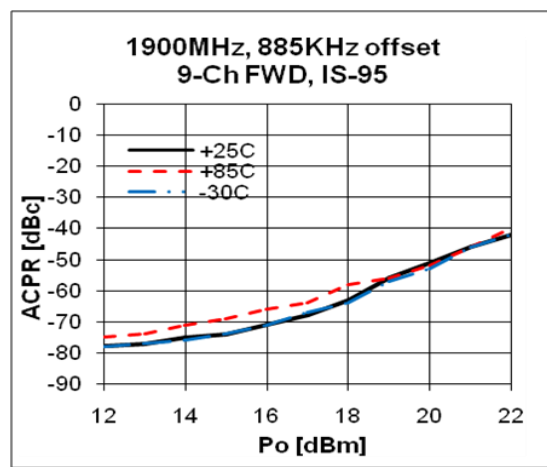
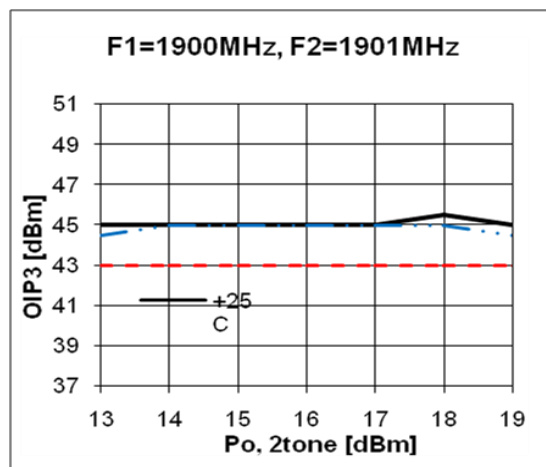
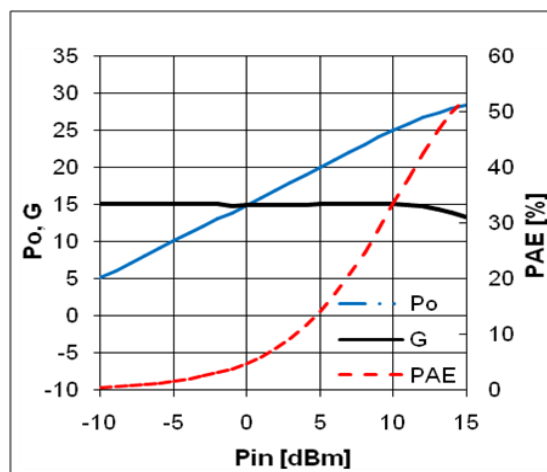
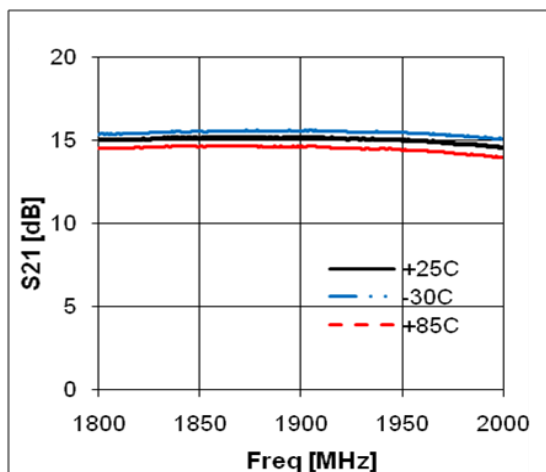
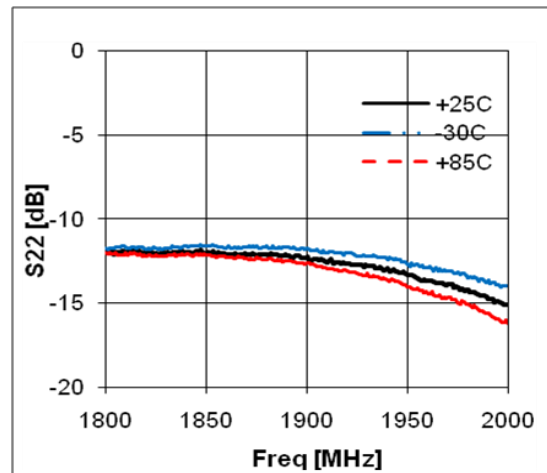
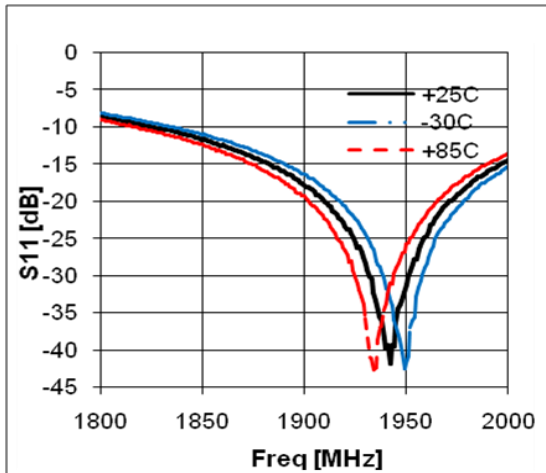
Freq [MHz]	S11 [Mag]	S11 [Ang]	S21 [Mag]	S21 [Ang]	S12 [Mag]	S12 [Ang]	S22 [Mag]	S22 [Ang]
100	-0.046	-30.149	2.219	-128.4	-41.958	66.107	-3.497	165.97
500	-0.952	-116.77	6.737	-174.18	-32.703	25.318	-3.457	162.64
1000	-1.111	-162.01	13.26	161.56	-32.513	76.255	-7.557	117.5
1500	-0.928	157.99	10.718	121.35	-30.171	46.516	-7.780	127.17
2000	-1.240	129.31	9.181	101.55	-28.599	42.527	-7.262	116.25
2500	-1.390	104.6	8.334	81.201	-26.76	37.808	-7.180	97.537
3000	-1.669	82.694	6.491	66.725	-26.706	32.623	-7.38	74.648
3500	-1.989	60.455	6.124	51.795	-25.792	26.141	-7.336	50.666
4000	-2.281	37.752	5.024	33.795	-24.653	20.698	-6.823	32.131

WCDMA 6FA 2140 -55dBc

WCDMA 6FA 2140 -60dBc


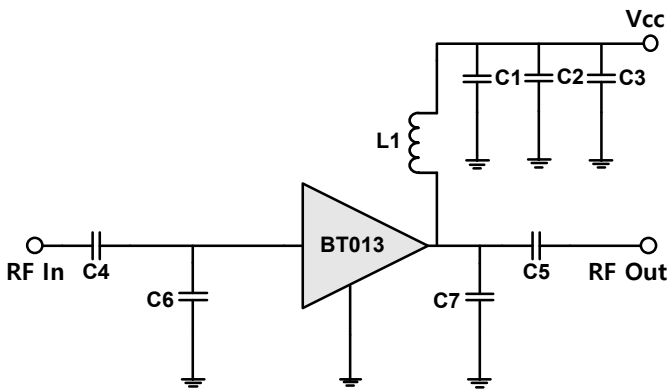
Application Circuit: 1900 MHz

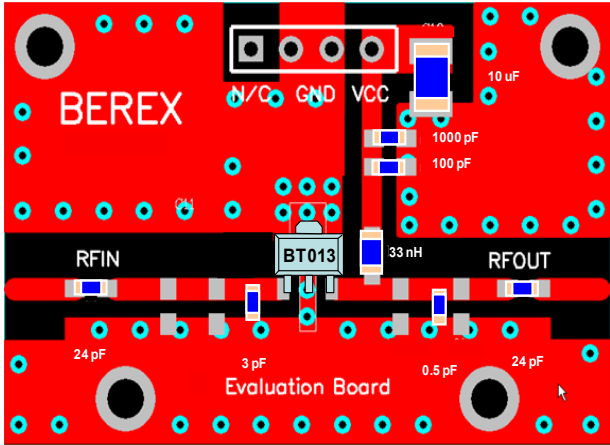
Schematic Diagram	BOM	Tolerance
	C1	100pF ±5%
	C2	1000pF ±5%
	C3	10uF ±20%
	C4	22pF ±5%
	C5	22pF ±5%
	C6	3pF ±5%
	C7	0.5pF ±5%
	L1	100nH ±5%
	<p>Note:</p> <ol style="list-style-type: none"> 1. PCB: 31mil thick FR4. 2. Distance between the center of the shunt cap (C6) and the input pin of BT013 <u>3.2mm</u>. 3. Distance between the center of the shunt cap (C7) and the output pin of BT013 <u>8.3mm</u>. 	

Typical Performance
(Vc=5V, Ic=135mA, T=25°C)

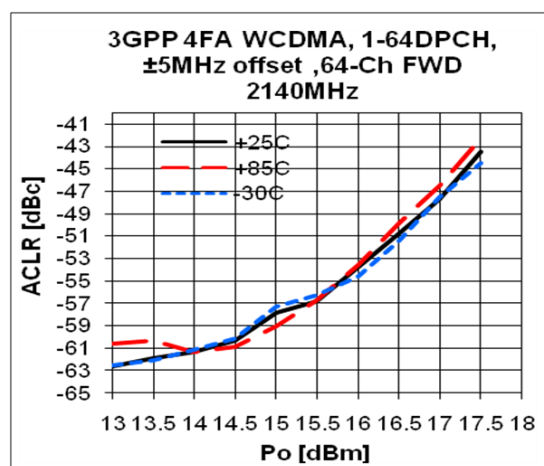
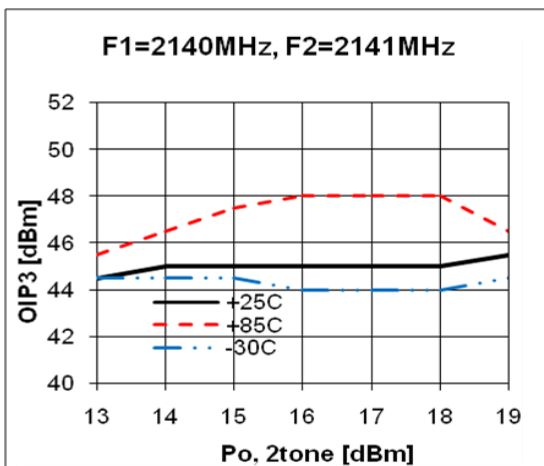
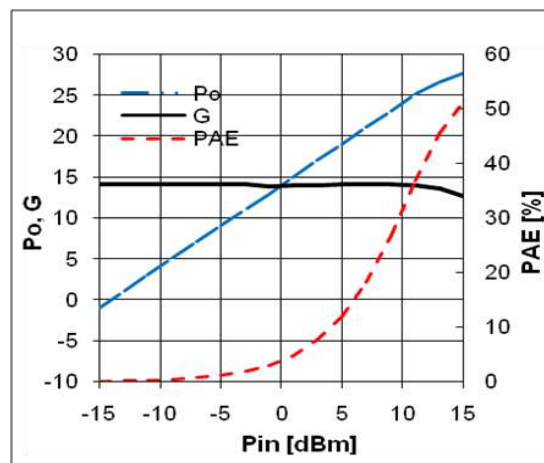
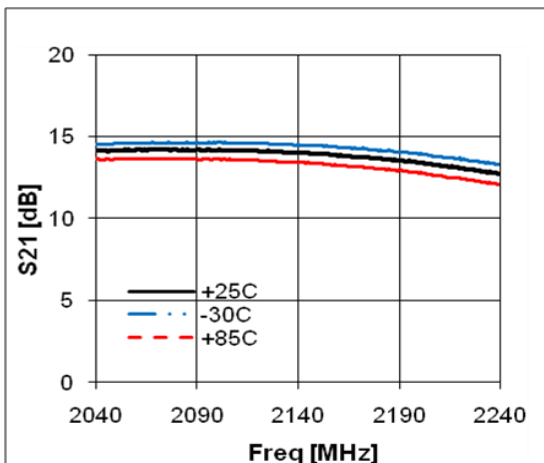
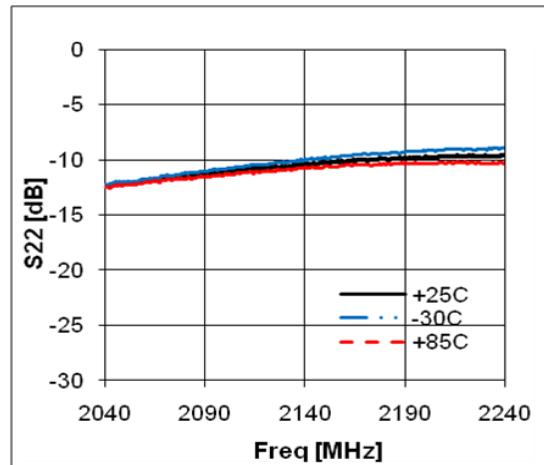
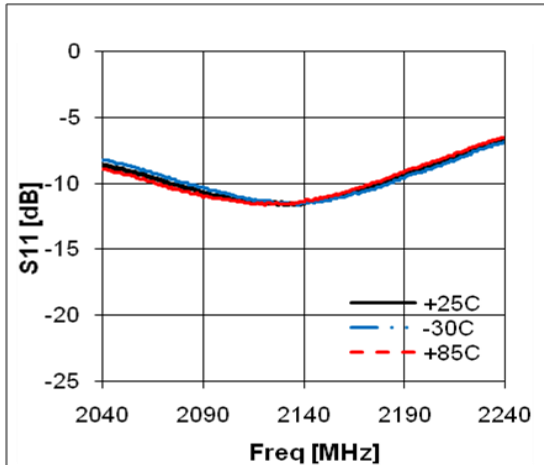


Application Circuit: 2140MHz

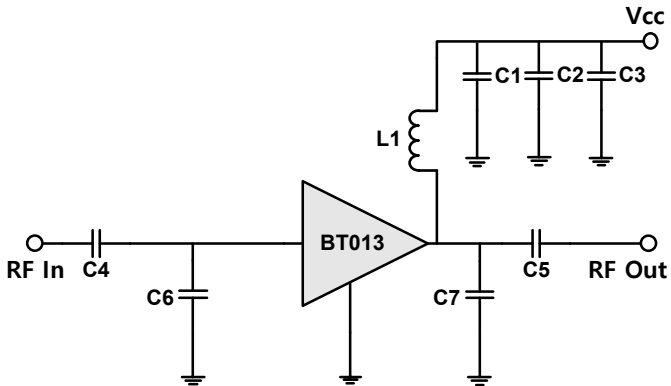
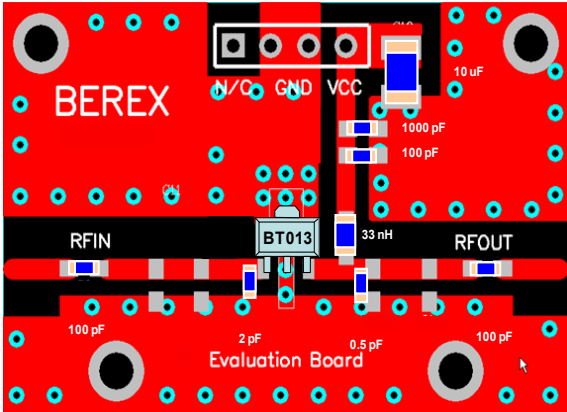
Schematic Diagram		BOM	Tolerance	
		C1	100pF	±5%
		C2	1000pF	±5%
		C3	10uF	±20%
		C4	24pF	±5%
		C5	24pF	±5%
		C6	3pF	±5%
		C7	0.5pF	±5%
		L1	33nH	±5%

	<p>Note:</p> <ol style="list-style-type: none"> 1. PCB: 31mil thick FR4 2. Distance between the center of the shunt cap (C6) and the input pin of BT013 <u>1.5mm.</u> 3. Distance between the center of the shunt cap (C7) and the output pin of BT013 <u>6.4mm.</u>
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Typical Performance (Vc=5V, Ic=135mA, T=25°C)

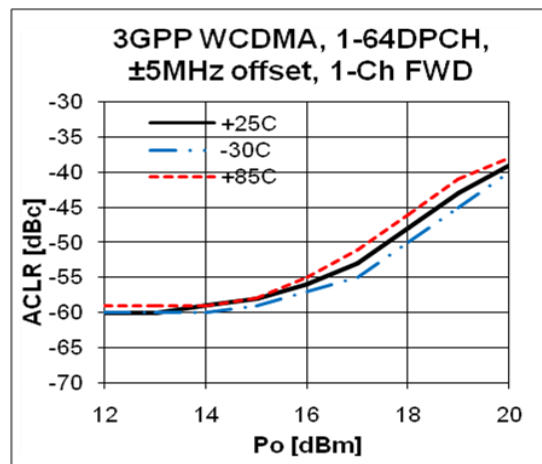
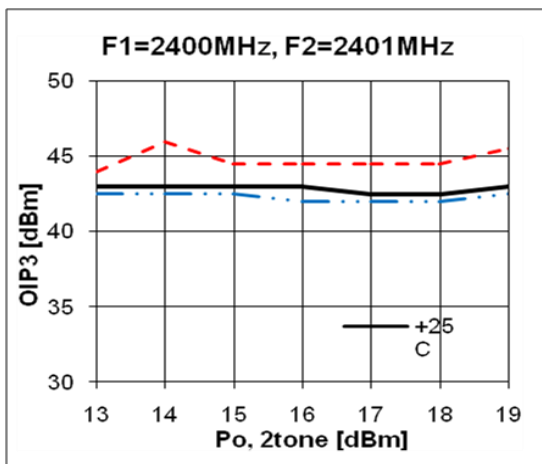
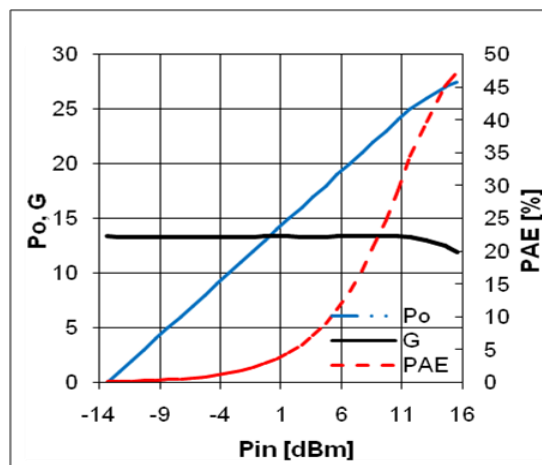
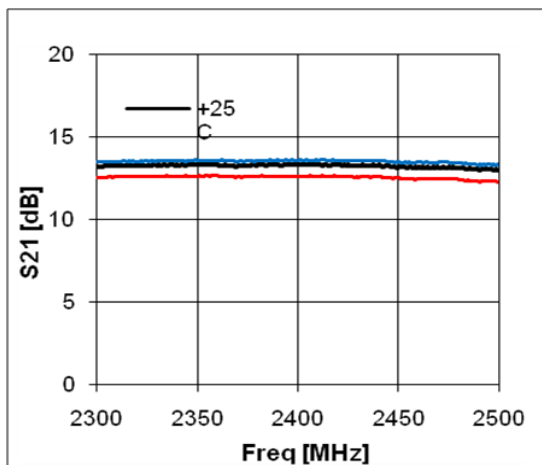
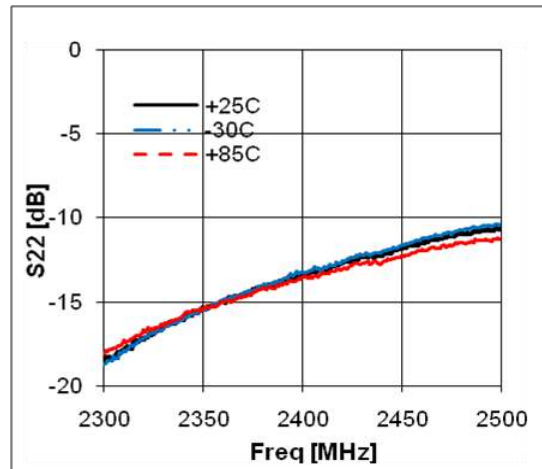
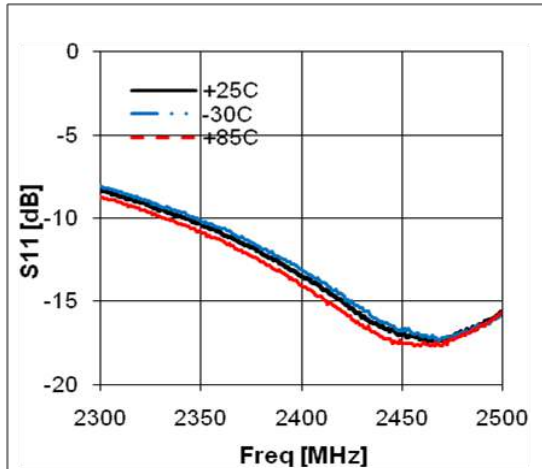


Application Circuit: 2400MHz

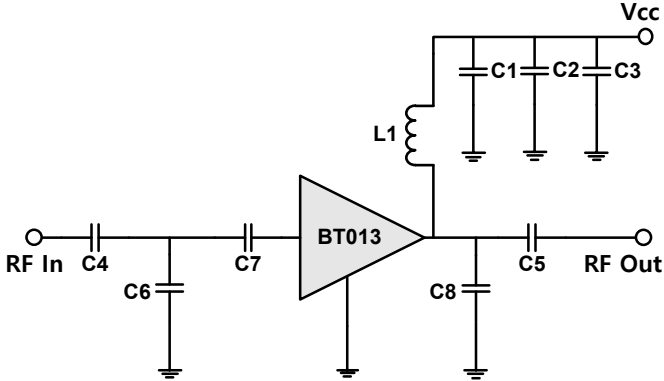
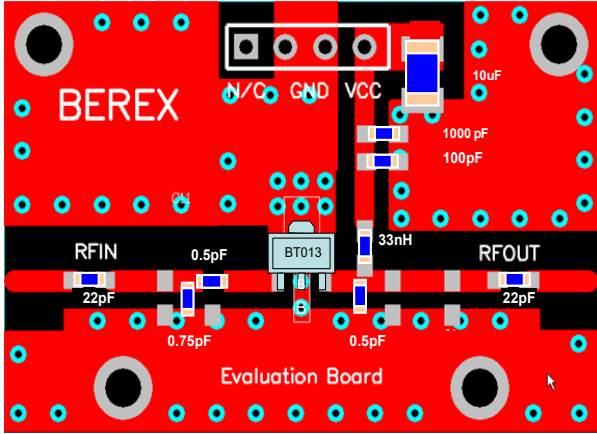
Schematic Diagram	BOM	Tolerance
	C1	100pF ±5%
	C2	1000pF ±5%
	C3	10uF ±15%
	C4	100pF ±5%
	C5	100pF ±5%
	C6	2pF ±5%
	C7	0.5pF ±5%
	L1	33nH ±5%
	<p>Note:</p> <ol style="list-style-type: none"> 1. PCB: 31mil thick FR4 2. Distance between the center of the shunt cap (C6) and the input pin of BT013 <u>0.7mm.</u> 3. Distance between the center of the shunt cap (C7) and the output pin of BT013 <u>3.2mm.</u> 	

Typical Performance

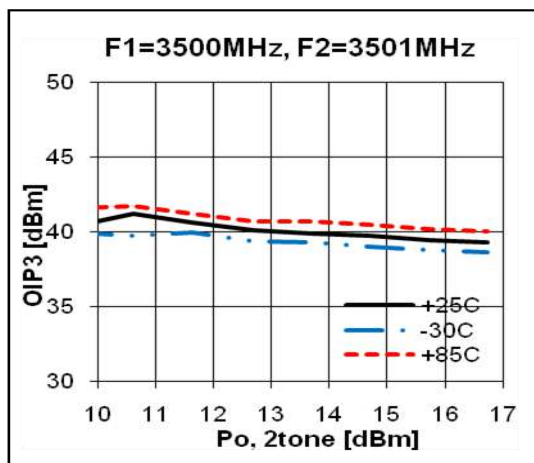
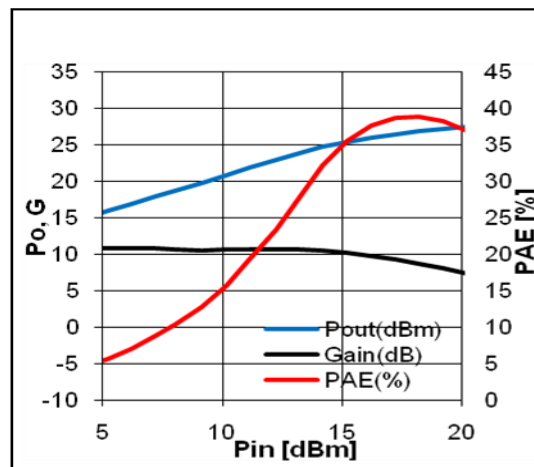
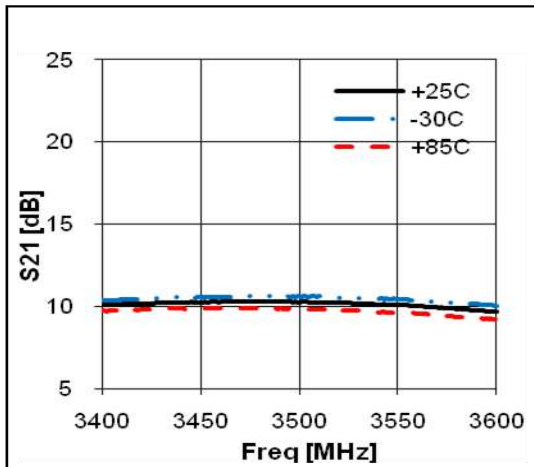
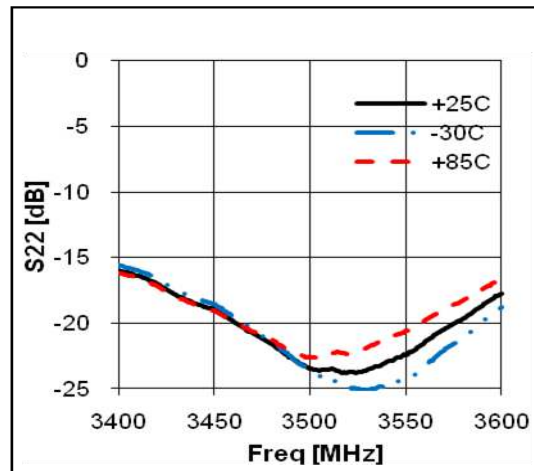
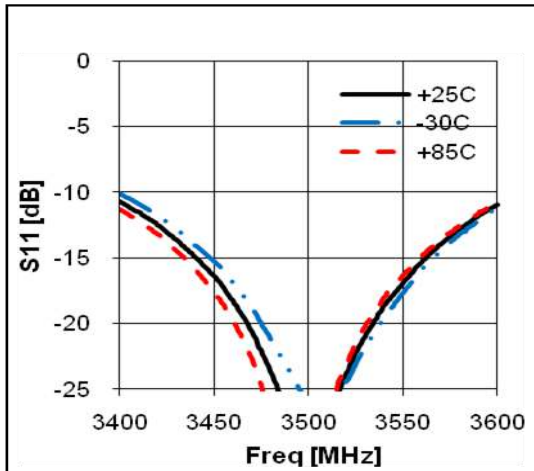
($V_c=5V, I_c=135mA, T=25^\circ C$)



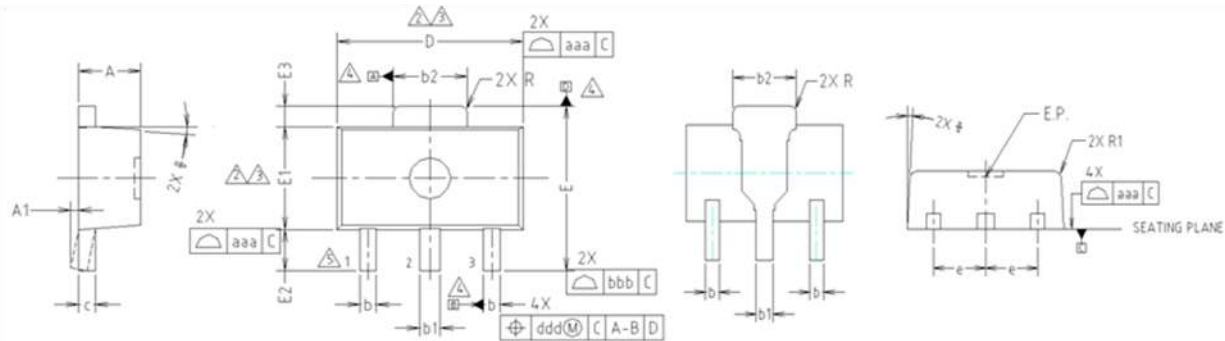
Application Circuit: 3500MHz

Schematic Diagram	BOM	Tolerance
	C1	100pF ±5%
	C2	1000pF ±5%
	C3	10uF ±20%
	C4	22pF ±5%
	C5	22pF ±5%
	C6	0.75pF ±5%
	C7	0.5pF ±5%
	C8	0.5pF ±5%
L1	33nH ±5%	
	<p>Note:</p> <ol style="list-style-type: none"> 1. PCB: 31mil thick FR4 2. Distance between the center of the shunt cap (C6) and the input pin of BT013 _ <u>10mm.</u> 3. Distance between the center of the series cap (C7) and the input pin of BT013 _ <u>4mm.</u> 4. Distance between the center of the shunt cap (C8) and the output pin of BT013 _ <u>3mm.</u> 	

Typical Performance
($V_c=5V$, $I_c=135mA$, $T=25^\circ C$)



Package Outline Dimension

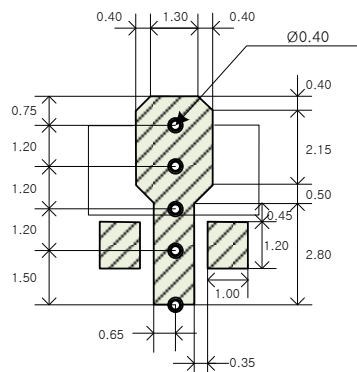


- NOTE:**
 1. DIMENSIONS IN MILLIMETERS.
- ⚠ DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.5mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.5mm PER SIDE.
 - ⚠ DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
 - ⚠ DATUMS A, B AND D TO BE DETERMINED 0.18mm FROM THE LEAD TIP.
 - ⚠ TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	1.40	1.50	1.60	
A1	0.00	—	0.10	
b	0.38	0.42	0.48	
b1	0.48	0.52	0.58	
b2	1.79	1.82	1.87	
c	0.40	0.42	0.46	
D	4.40	4.50	4.70	2,3
E	3.70	4.00	4.30	
E1	2.40	2.50	2.70	2,3
E2	0.80	1.00	1.20	
E3	0.40	0.50	0.60	
e	1.50 TYP.			
φ	4° TYP.			
R	0.15 TYP.			
R1	—	—	0.20	
SYMBOL	TOLERANCES OF FORM AND POSITION		NOTE	
aaa	0.15			
bbb	0.20			
ccc	0.10			
ddd	0.10			

Suggested PCB Land Pattern and PAD Layout

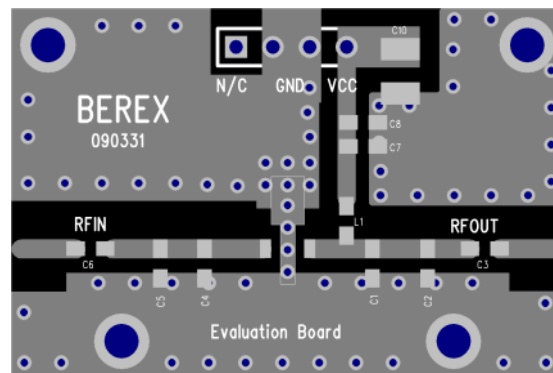
PCB Land Pattern



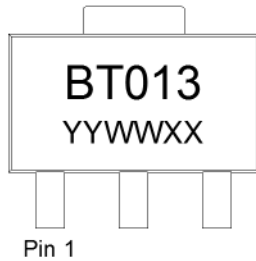
Note : All dimension are in millimeters

PCB lay out _ on BeRex website

PCB Mounting



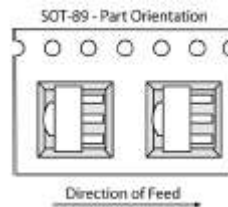
Package Marking



YY = Year, WW = Working Week,
XX = Wafer No.

Tape & Reel

SOT89



Packaging information:

Tape Width (mm): 12
Reel Size (inches): 7
Device Cavity Pitch (mm): 8
Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating:	Class 1C
Value:	Passes <2000V
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JS-001-2017
MSL Rating:	Level 1 at +260°C convection reflow
Standard:	JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling this device.

RoHS Compliance

This part is compliant with Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

NATO CAGE code:

2	N	9	6	F
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